



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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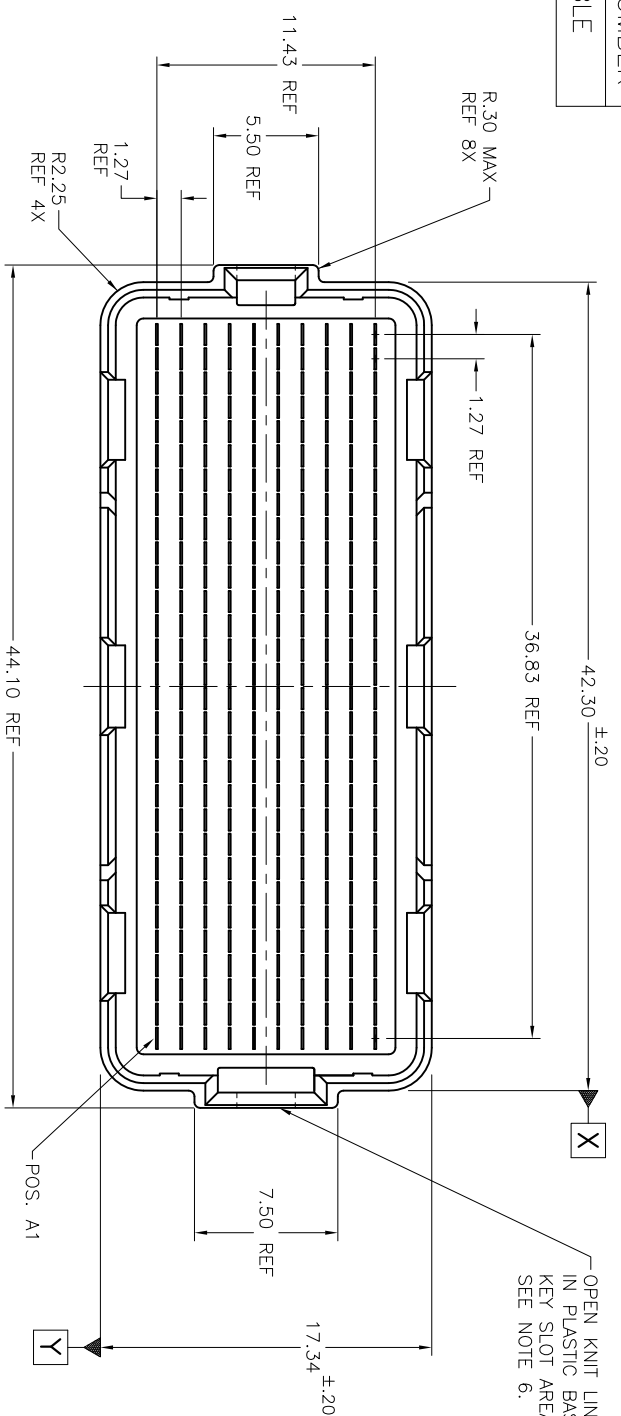


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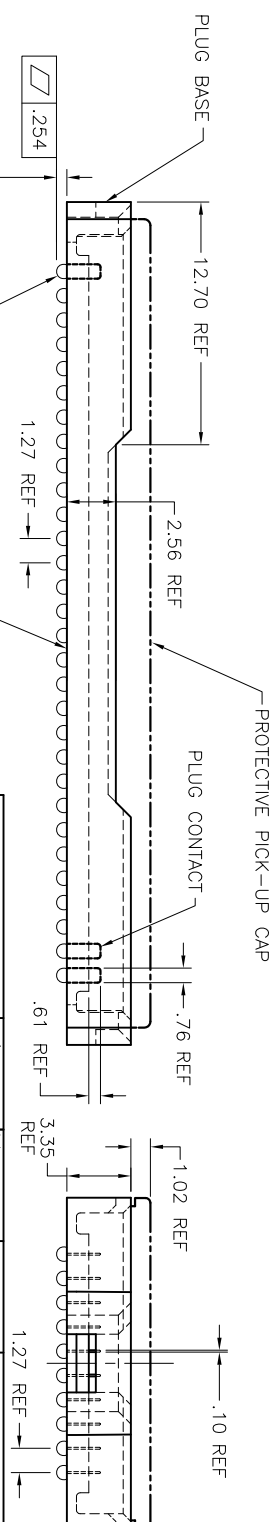


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PRODUCT NUMBER
SEE TABLE



OPEN KNIT LINES PERMISSIBLE IN PLASTIC BASE COMPONENT KEY SLOT AREAS (BOTH ENDS). SEE NOTE 6.



CONTINUOUS OPEN KNIT LINE CRACKS (TRAVERSING THE ENTIRE BODY LENGTH OF THE CONNECTOR) WHICH CAUSE CRITICAL-TO-FUNCTION DIMENSIONAL CHANGES THAT AFFECT THE CONNECTORS MECHANICAL ALIGNMENT FEATURES ARE NOT PERMISSIBLE. SEE NOTE 6.

Mat'l code	SEE NOTE 1	date	surface	tolerance	projection	product family	title
ltr	ecn no.	dfr	ASPE Y14.5	ASPE Y14.5	ASPE Y14.5	MEG-ARRAY	0mm PLUG ASSEMBLY
K	V06-0560	LP	2006-07-14	intolerances unless otherwise specified	XXX-13		10 X 30 = 300 POSITIONS
L	V11-0029	HTB	2011-06-06		XXX-13		Sheet 1 of 5
M	V12-0030	SJ	2012-08-06	0' ±.2"	XXX-0051		84500
N	V12-0036	DCH	2012-11-13	D. WAUGHEN			A4
P	V-18084	DCH	2014-6-25	D. HARPER			CUSTOMER Drawing
R	V-21139	RWB	2015-06-12	D. HARPER			
Sheet	revision	R	R	R	R	R	
index	Sheet	1	2	3	4	5	

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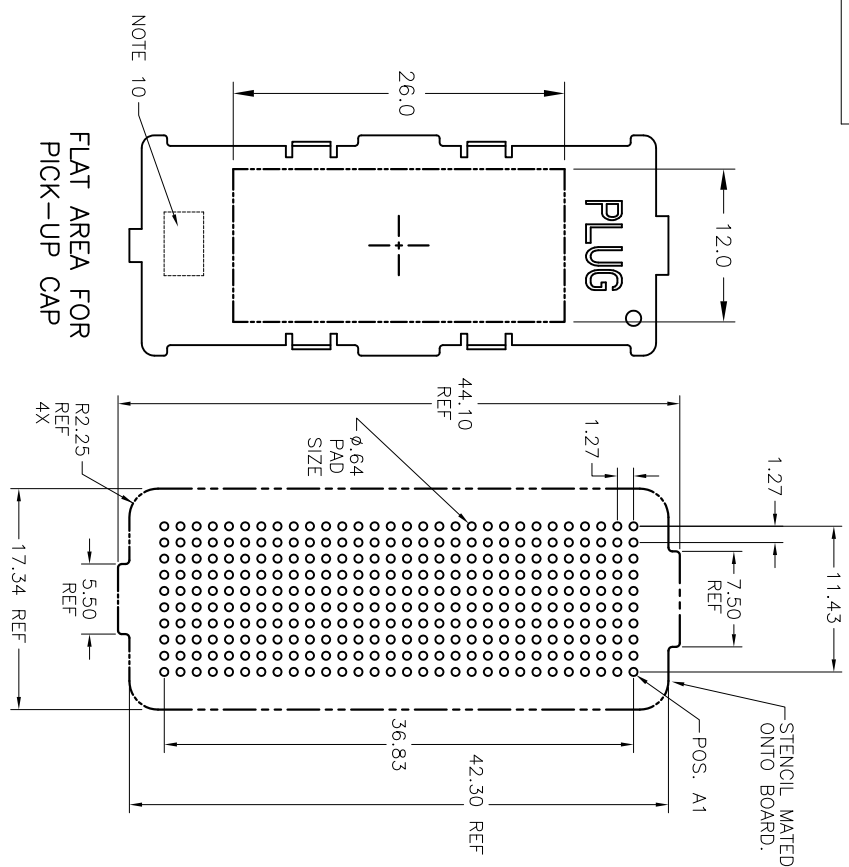


PRODUCT NUMBER
SEE TABLE

1 | 2

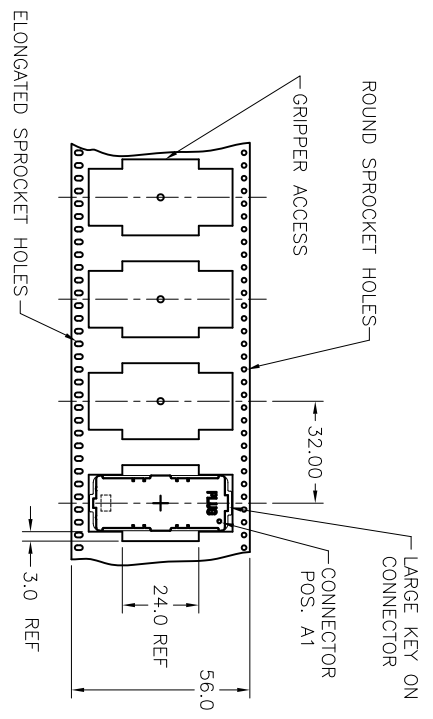
3 |

4



NOTE 10
FLAT AREA FOR
PICK-UP CAP

BOARD PATTERN



TAPE & REEL PACKAGING SCALE: NONE
PER EIA 481-3

mat'l code	SEE NOTE 1	surface	ASME Y14.5	tolerance	ASME Y14.5	projection	product family
ltr	ecm no	dfr	date	indicators unless otherwise specified			MEG-ARRAY
R			angles	XXX.X3	XXX.X3	MM	0mm PLUG ASSEMBLY
			or ±2°	XXXX.051	XXXX.051	Scale: 2:1	10 X 30 = 300 POSITIONS
			dfr	D. WAUGHEN	999-12-16		dwg no
			plgjr	D. HARPER	999-12-16		84500
			cltr	D. HARPER	999-12-16		Sheet 2 of 5
			qddi	D. HARPER	999-12-16		size
sheet index	revision						A4
							CUSTOMER Drawing

form: A4mmX16

1 |

2 |

3 |

4



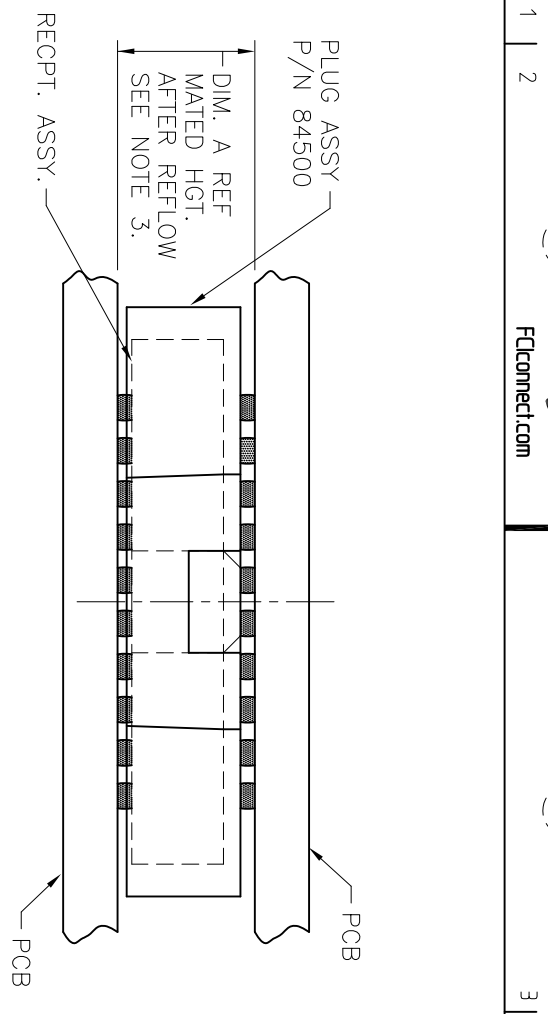
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PRODUCT NUMBER
SEE TABLE



MATED HEIGHT TABLE		
DIM. A	RECP. ASSY. P/N	PLATING
4.0	84501	SEE NOTE 4.
5.5	84502	*
8.0	84553	SEE NOTE 5.

* 84502 NOT AVAILABLE IN TELCORDIA/NORTEL VERSION.

MATED HEIGHT AFTER REFLOW IS BASED ON ϕ .64mm PAD (METAL-DEFINED) AND .13mm SOLDER PASTE STENCIL THICKNESS. SEE NOTE 3.

END VIEW - MATED CONNECTORS SCALE: NONE

mat'l. code	surface	tolerance	projection	product family
SEE NOTE 1	ASME Y14.5	ASME Y14.5		MEG-ARRAY
litr. eqn no. dfr. date	tolerances unless otherwise specified			
R	angles	X.3	MM	title
	ϕ	XXX.X	Scale: 2:1	0mm PLUG ASSEMBLY
	ϕ	XXX.X		10 X 30 = 300 POSITION
	dfr.	D. WAUGHEN		Sheet 3 of 5
	plngj	D. HARPER		size
	dlr.	D. HARPER		A4
	qddi	D. HARPER		CUSTOMER Drawing
sheet index	revision			

form: AdminXlc 1 2 3 4



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3 |

4

PRODUCT NUMBER	PICK-UP CAP (NATURAL OR BLACK IN COLOR)	CONTACT PLATING AND THICKNESS	SOLDER BALL	NOTES
84500-002	YES	15µ" (.38µm) Au	SnPb	
84500-002LF	YES	15µ" (.38µm) Au	LEAD FREE	7 & 8
84500-092	YES	15µ" (.38µm) GXT	SnPb	
84500-092LF	YES	15µ" (.38µm) GXT	LEAD FREE	7 & 8
84500-093	WITH VENT HOLES	15µ" (.38µm) GXT	SnPb	7 , 8
84500-093LF	WITH VENT HOLES	15µ" (.38µm) GXT	LEAD FREE	7 , 8
84500-102	YES	30µ" (.76µm) Au	SnPb	
84500-102LF	YES	30µ" (.76µm) Au	LEAD FREE	7 & 8
84500-192	YES	30µ" (.76µm) GXT	SnPb	
84500-192LF	YES	30µ" (.76µm) GXT	LEAD FREE	7 & 8
84500-202	YES	50µ" (1.27µm) Au SPECIAL	SnPb	4, & 5
84500-202LF	YES	50µ" (1.27µm) Au SPECIAL	LEAD FREE	4, 5, 7 & 8
84500-292	YES	50µ" (1.27µm) GXT SPECIAL	SnPb	4, & 5
84500-292LF	YES	50µ" (1.27µm) GXT SPECIAL	LEAD FREE	4, 5, 7, & 8
84500-A02	YES	30µ" (.76µm)	SnPb	9
84500-A02LF	YES	30µ" (.76µm)	LEAD FREE	7, 8 & 9

mat'l. code	code	SNPb	surface	tolerance	projection	product family
SEE NOTE 1	1	1	ASPE Y14.5	ASPE Y14.5	ASPE Y14.5	MEG-ARRAY
litr	ecm no	dfr	date	ASPE Y14.5	ASPE Y14.5	
R			angles	XXX.X3	XXX.X3	
			o' ±2"	XXX.X051	XXX.X051	
			dfr	T. BREWBAKER	2011-06-06	
			pngr	T. BREWBAKER	2011-06-06	
			cltr	T. BREWBAKER	2011-06-06	
			apdd	D. HORCHLER	2011-06-06	
sheet	revision					
index	sheet					

10 X 30 = 300 POSITIONS
 Omni PLUG ASSEMBLY
 Dwg no 84500 Sheet 4 of 5 Size A4
 CUSTOMER Drawing



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PRODUCT NUMBER
SEE TABLE

1 | 2

3 |

4

NOTES:

1. MATERIAL:

HOUSING: LCP
CONTACT: COPPER ALLOY

PLATING:

CONTACT: (SEE TABLE)
SOLDER BALL: (SEE TABLE)
EUTECTIC SnPb OR LEAD FREE
95.5Sn/4Ag/0.5Cu

2. SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.

3. MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE.

4. PLATING FOR INDICATED -2XX SERIES PRODUCT NUMBERS MEET THE REQUIREMENTS OF (GR-1217-CORE, CENTRAL OFFICE ENVIRONMENT, 25 YEAR LIFE EXPECTANCY).

5. PLATING FOR INDICATED -2XX SERIES PART NOS. IS AU OVER Ni WITH SPECIAL CONTACT GEOMETRY TO MEET REQUIREMENTS OF TELCORDIA GR-1217-CORE: CENTRAL OFFICE ENVIRONMENT.

6. KNT LINE: SLIGHT VISIBLE MARKS (USUALLY A LINE) INDICATING THE DIRECTION AND MEETING POINT OF PLASTIC RESIN FLOW FRONTS TRAVELING AROUND ANY OBSTRUCTIONS TO THE RESIN FLOW VIA THE REQUIRED MOLD TOOLING.



7. FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THEREFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.

8. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION.

9. 84500-A02 AND -A02LF ARE CUSTOMER SPECIALS.

10. CURRENT COMPANY LOGO TO BE VISIBLE IN APPROXIMATE AREA SHOWN.

11. A  SYMBOL WILL BE NEXT TO ANY DIMENSION, NEW VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION

mat'l code	SEE NOTE 1	surface	tolerance	projection	product family
lfr	ecm no	dr	date	ASME Y14.5	ASME Y14.5
R		angles	3x3		MEG-ARRAY
		0' ±2"	XXXX.051	MM	title
		dr	T. BREWBAKER	Scale: 2:1	10 X 30 = 300 POSITIONS
		plgjr	T. BREWBAKER		dwg no
		cltr	T. BREWBAKER		84500
		qddi	D. HORCHLER		sheet 5 of 5
sheet	revision				size
index	sheet				A4

form: AdminXic

1

2

3

4

B

A

B

A